SN54194, SN54LS194A, SN54S194, SN74194, SN74LS194A, SN74S194 4-BIT BIDIRECTIONAL UNIVERSAL SHIFT REGISTERS

MARCH 1974-REVISED MARCH 1988

- Parallel Inputs and Outputs
- Four Operating Modes:

Synchronous Parallel Load Right Shift Left Shift Do Nothing

- Positive Edge-Triggered Clocking
- Direct Overriding Clear

TYPE	TYPICAL MAXIMUM CLOCK FREQUENCY	TYPICAL POWER DISSIPATION
194	36 MHz	195 mW
'LS194A	36 MHz	75 mW
' S194	105 MHz	425 mW

description

These bidirectional shift registers are designed to incorporate virtually all of the features a system designer may want in a shift register. The circuit contains 46 equivalent gates and features parallel inputs, parallel outputs, right-shift and left-shift serial inputs, operating-mode-control inputs, and a direct overriding clear line. The register has four distinct modes of operation, namely:

Inhibit clock (do nothing)
Shift right (in the direction Q_A toward Q_D)
Shift left (in the direction Q_D toward Q_A)
Parallel (broadside) load

Synchronous parallel loading is accomplished by applying the four bits of data and taking both mode control inputs, SO and S1, high. The data are loaded into the associated flip-flops and appear at the outputs after the positive transition of the clock input. During loading, serial data flow is inhibited.

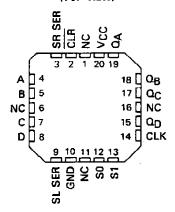
Shift right is accomplished synchronously with the rising edge of the clock pulse when SO is high and S1 is low. Serial data for this mode is entered at the shift-right data input. When SO is low and S1 is high, data shifts left synchronously and new data is entered at the shift-left serial input.

Clocking of the shift register is inhibited when both mode control inputs are low. The mode controls of the SN54194/SN74194 should be changed only while the clock input is high.

SN54194, SN54LS194A, SN54S194 . . . J OR W PACKAGE SN74194 . . . N PACKAGE SN74LS194A, SN74S194 . . . D OR N PACKAGE (TOP VIEW)

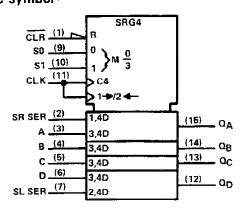
CLR	<u></u> 1	U 16	D∨cc
SR SER	[]2	15	Q _A
Α	□3	14	□ов
В		13	□ oc
C	□5	12	_ σ _D
D	∏6	11	Crk
SL SER	٦7	10	_ S1
GND	<u>[</u> 8_	9	_ so

SN54LS194A, SN54S194 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

logic symbol†



 $^{^{\}dagger} This$ symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D. J. N. and W packages.

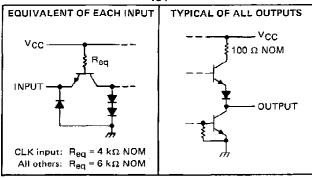
FUNCTION TABLE

				INPUT	S						OUT	PUTS	
	MO	DE	01.00%	SE	HAL _		PARA	LLE		_	_		Δ-
CLEAR	S1	SO	CLOCK	LEFT	RIGHT	Α	В	С	D	QA	QΒ	σc	σD
L	Х	Х	х	Х	х	х	Х	Х	X	L,	L	L	L
H	Х	×	L	х	X	×	Х	Х	Х	Q _{A0}	Q_{B0}	a_{co}	a_{D0}
Н	Н	Н	t	х	х	а	b	c	d	a	b	c	d
Н	L	н	†	Х	H.	×	×	X	×	н	$Q_{A\Pi}$	Q_{Bn}	α_{Cn}
н	L	Н	†	х	L	х	Х	Х	Х	Ł	o_{An}	o_{Bn}	$Q_{C\Pi}$
Н	Н	L	†	Н	X	х	×	X	×	QBn	α_{Cn}	α_{Dn}	н
н	Н	L	ı	L	х	х	Х	Х	X	QBn	α_{Cn}	$\sigma_{D^{\Pi}}$	L
н	L	L.	×	X	х	х	Х	Х	Х	α_{A0}		σ_{CO}	Q _{D0}

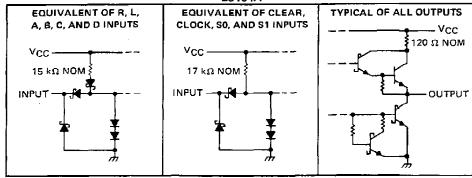
- H = high level (steady state)
- L = low level (steady state)
- X = irrelevant (any input, including transitions)
- 1 = transition from low to high level
- a, b, c, d = the level of steady-state input at inputs A, B, C, or D, respectively.
- QAO, QBO, QCO, QDO = the level of QA, QB, QC, Or QD, respectively, before the indicated steady-state input conditions were established.
- Ω_{An} , Ω_{Bn} , Ω_{Cn} , Ω_{Dn} = the level of Q_A , Ω_B , Ω_C , respectively, before the most-recent \uparrow transition of the clock.

schematics of inputs and outputs

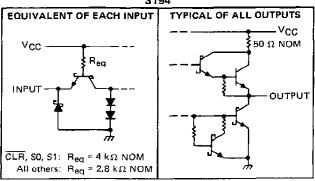
194



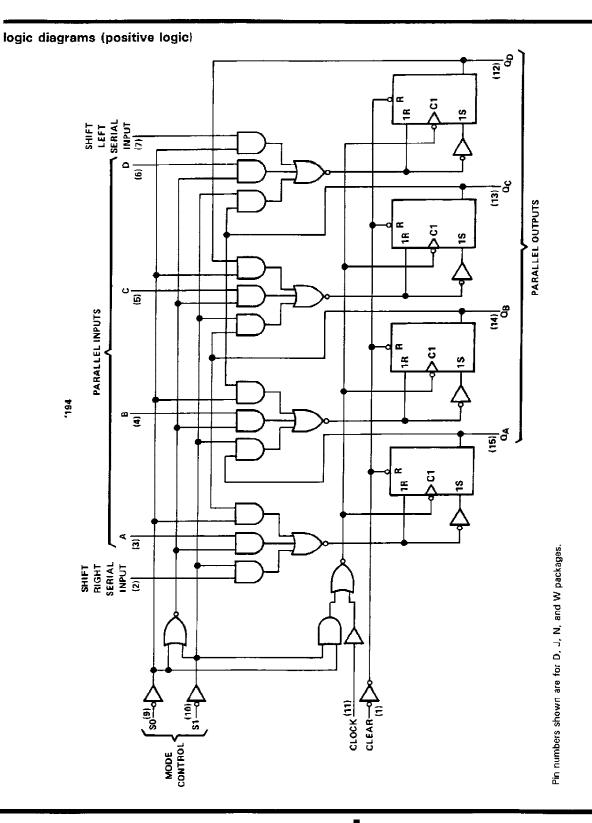
'LS194A

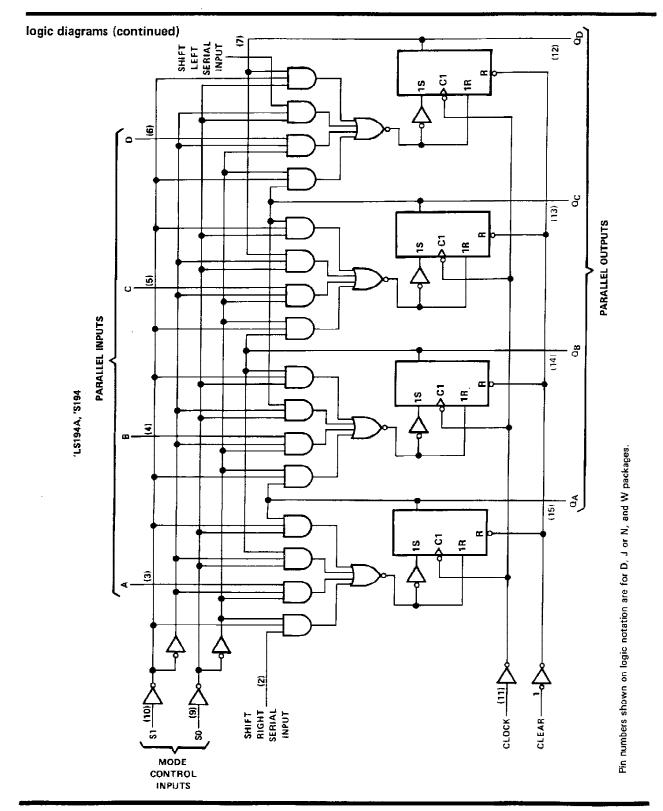


'S194

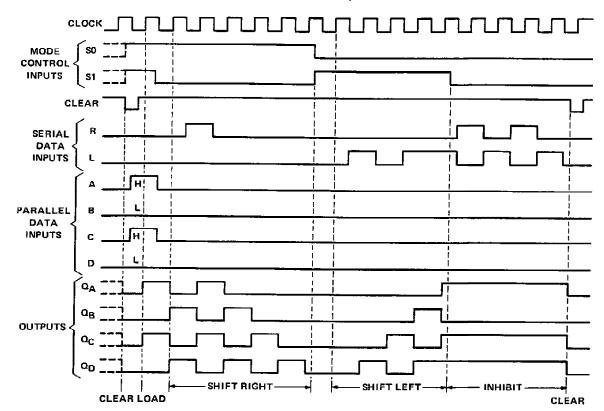


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typical clear, load, right-shift, left-shift, inhibit, and clear sequences



SN54194, SN74194 4-BIT BIDIRECTIONAL UNIVERSAL SHIFT REGISTERS

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)			 			 					7 V
Input voltage											
Operating free-air temperature range:	SN54194										-55°C to 125°C
											. 0°C to 70°C
Storage temperature range		,						•			-65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

			SN5419	4		SN7419	4	
		MIN	MOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}		4.5	5	5,5	4.75	5	5.25	٧
High-level output current, IOH				-800			-800	μА
Low-level output current, IQL				16			16	mA
Clock frequency, f _{clock}	0		25	0		25	MHz	
Width of clock or clear pulse, tw	20			20			ns	
	Mode control	30			30			ns
Setup time, t _{SU}	Serial and parallel data	20			20	-		ns
	Clear inactive-state	25			25			ns
Hold time at any input, t _h		0			0			пѕ
Operating free-air temperature, TA		-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

Γ	PARAMETER		NO TIONS		SN5419	4	\$N74194				
	PARAMETER	TEST CO	NDITIONS†	MIN	түр‡	мах	MIN	TYP‡	MAX	UNIT	
VIH	High-level input voltage			2			2			V	
VIL	Low-level input voltage					8.0			0.8	٧	
VIK	Input clamp voltage	V _{CC} = MIN,	l _I = -12 mA			-1.5		·	-1.5	٧	
νон	High-level output voltage	V _{CC} = MIN, V _{IL} = 0.8 V,	V _{1H} = 2 V, I _{OH} = -800 μA	2.4	3.4		2.4	3.4		٧	
VOL	Low-level output voltage	V _{CC} = MIN, V _{IL} = 0.8 V,	V _{IH} = 2 V, I _{OL} = 16 mA	_	0.2	0.4		0.2	0.4	٧	
lj.	Input current at maximum input voltage	V _{CC} = MAX,	V ₁ = 5.5 V			1			1	mΑ	
ΉΗ	High-level input current	V _{CC} = MAX,	V _I = 2.4 V			40			40	μА	
I _I L	Low-level input current	VCC = MAX.	V ₁ = 0.4 V		<u>-</u>	1.6	_	,	-1.6	mA	
los	Short-circuit output current §	V _{CC} = MAX		-20		-57	-18		-57	mA	
Icc	Supply current	V _{CC} = MAX,	See Note 2		39	63		39	63	mA	

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: With all outputs open, inputs A through D grounded, and 4.5 V applied to S0, S1, clear, and the serial inputs, I_{CC} is tested with a momentary GND, then 4.5 V applied to clock.

switching characteristics, VCC = 5 V, TA = 25 °C

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
fmax	Maximum clock frequency	C. 15 - F	25	36		MHz
TPHL	Propagation delay time, high-to-low-level output from clear	C _L = 15 pF,		19	30	us
^t PLH	Propagation delay time, low-to-high-level output from clock	$R_L = 400 \Omega$		14	22	ns
tPHL	Propagation delay time, high-to-low-level output from clock	See Figure 1		17	26	ns



 $^{^\}ddagger$ All typical values are at V_{CC} = 5 V, T_A = 25°C.

Not more than one output should be shorted at a time.

SN54LS194A, SN74LS194A 4-BIT BIDIRECTIONAL UNIVERSAL SHIFT REGISTERS

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)														7 V
Input voltage					 -									7 V
Operating free-air temperature range:	SN54LS194A										-5	5°C	to	125°C
	SN74LS194A			,				 ,				0°(O to	70°C
Storage temperature range		_									-6	5°C	to	150°C

NOTE 1: Voltage values are with respect to network ground terminal,

recommended operating conditions

		SN	154LS19	94Δ	SN	SN74LS194A			
		MIN	MOM	MAX	MIN	NOM	MAX	UNIT	
Supply voltage, V _{CC}		4.5	5	5.5	4.75	5	5.25	V	
High-level output current, IOH	-			-40 0			-400	μА	
Low-level output current, IQL				4	1		8	mΑ	
Clock frequency, fclock	0		25	0		25	MHz		
Width of clock or clear pulse, t _W		20			20			กร	
	Mode control	30			30			ns	
Setup time, t _{SU}	Serial and parallel data	20			20			ns	
	Clear inactive-state	25			25			ns	
Hold time at any input, ^t h		0			0			ns	
Operating free-air temperature, TA		-55		125	0		70	°C	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	DADAMETED	-	ST CONDITIO	anet	SN	154LS19	4A	SN	4A		
	PARAMETER	'=	SICONDIIIC	SM2.	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIH	High-level input voltage				2			2			V
VIL	Low-level input voltage						0.7			8.0	V
٧١	Input clamp voltage	V _{CC} - MIN,	l₁ = −18 mA	1	1		-1.5			-1.5	·V
v _{OH}	High-level output voltage	V _{CC} = MIN, V _{IL} = V _{IL} max	V _{IH} = 2 V,	μΑ	2.5	3.5	, , , , , ,	2.7	3.5		٧
· · ·	Law law Law and Community of Sana	V _{CC} = MIN,	V _{IH} = 2 V,		0.25	0.4		0.25	0.4	V	
VOL	Low-level output voltage	VIL = VIL max	!	I _{OL} = 8 mA					0.35	0.5	V
f ₁	Input current at maximum input voltage	V _{CC} = MAX,	V ₁ = 7 V				0.1			0.1	mA
Чн	High-level input current	V _{CC} = MAX,	V _I = 2.7 V				20			20	μА
i ₁ L	Low-level input current	V _{CC} = MAX,	V ₁ = 0.4 V		1		-0.4			-0.4	mΑ
los	Short-circuit output current §	VCC = MAX			-20		-100	-20		-100	mA
Icc	Supply current	V _{CC} = MAX,	See Note 2		-	15	23		15	23	mΑ

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions,

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25 \text{ °C}$

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
fmax	Maximum clock frequency	Ci = 15 pF,	25	36		MHz
tPHL	Propagation delay time, high-to-low-level output from clear	$C_{L} = 15 \text{ pr.}$ $R_{1} = 2 \text{ k}\Omega.$		19	30	ns
tPLH	Propagation delay time, low-to-high level output from clock	See Figure 1		14	22	វាទ
tPHL	Propagation delay time, high-to-low level output from clock	See rigure 1		17	26	ns



 $[\]frac{1}{4}$ All typical values are at V_{CC} = 5 V, T_{A} = 25°C.

Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTE 2: With all outputs open, inputs A through D grounded, and 4.5 V applied to S0, S1, clear, and the serial inputs, I_{CC} is tested with a momentary GND, then 4.5 V, applied to clock.

SN54S194, SN74S194 4-BIT BIDIRECTIONAL UNIVERSAL SHIFT REGISTERS

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)									 							7 V
Input voltage																
Operating free-air temperature range:																-
:	SN74S194	•												0°C	to	, 70°C
Storage temperature range				_		_	_	_				_	-65	°C t	to '	150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN54S194			SN74S194			T
		MIN	NOM	MAX	MiN	NOM	MAX	רואט
Supply voltage, V _{CC}		4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH				-1			1	mA
Low-level output current, IOL				20			20	mA
Clock frequency, f _{clock}		0		70	0		70	MHz
Width of clock pulse, tw(clock)		7			7	-		ns
Width of clear pulse, tw(clear)		12		-	12			ns
	Mode control	11			11			ns
Setup time, t _{su}	Serial and parallel data	5			5			пs
	Clear inactive-state	9			9			ns
Hold time at any input, th		3			3			ns
Operating free-air temperature, TA		-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS!	SN54S194		9	UNIT			
FARANETER		TEST CONDITIONST	MIN TYP# MAX		MAX		MIN TYP# MAX		
v_{IH}	High-level input voltage		2			2			V
VIL	Low-level input voltage			-	0.8			0.8	V
٧ıĸ	Input clamp voltage	V _{CC} = MIN, I _I = -18 mA			-1.2			-1,2	V
νон	High-level output voltage	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = 0.8 V, I _{OH} = -1 mA	2,5	3.4		2.7	3.4		V
Vol	Low-level output voltage	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = 0.8 V, I _{OL} = 20 mA		-	0.5			0.5	V
1	Input current at maximum input voltage	VCC = MAX, V1 = 5.5 V			1			1	mA
ΙН	High-level input current	V _{CC} = MAX, V ₁ = 2.7 V		_	50			50	μА
III.	Low-level input current	V _{CC} = MAX, V _I = 0.5 V	İ		-2			-2	mA
los	Short-circuit output current§	V _{CC} = MAX	-40		-100	-40		-100	mA
	Supply current	V _{CC} = MAX, See Note 2	<u> </u>	85	135	<u> </u>	85	135	
¹cc		V _{CC} = MAX, T _A = 125°C, See Note 2			110				mA

For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, VCC - 5 V, TA - 25°C

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
f _{max}	Maximum clock frequency	0 - 15 -5	70	106		MHz
tpHL	Propagation delay time, high-to-low-level output from clear	Cլ = 15 pf,		12.5	18.5	ns
tpLH Propagation delay time, low-to-high-level output from clock		$R_L = 280 \Omega$,	4	8	12	n\$
tpHL	Propagation delay time, high-to-low-level output from clock	See Figure 1	4	11	16.5	ns

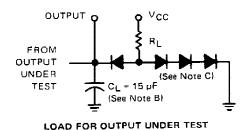


 $^{^{\}ddagger}$ All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25 ^{\circ}\text{C}$.

Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

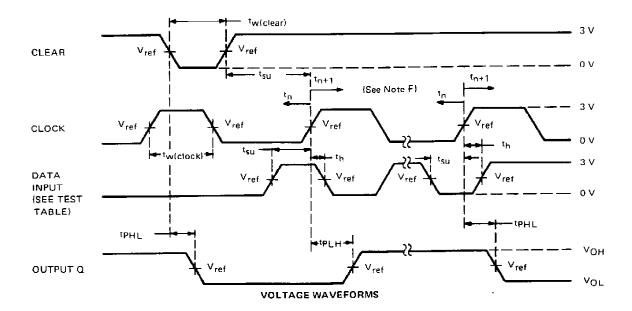
NOTE 2: With all outputs open, inputs A through D grounded, and 4.5 V applies to S0, S1, clear, and the serial inputs, I_{CC} is tested with a momentary GND, then 4.5 V, applied to clock.

PARAMETER MEASUREMENT INFORMATION



. TEST TABLE FOR SYNCHRONOUS INPUTS

DATA INPUT FOR TEST	S1	S0	OUTPUT TESTED (SEE NOTE E)
Α	4.5 V	4.5 V	Ω _A at t _{n+1}
В	4.5 V	4.5 V	Q _B at t _{n+1}
С	4.5 V	4.5 V	QC at tn+1
D	4.5 V	4.5 V	QD at tn+1
L Serial Input	4.5 ∨	0 V	Q _A at t _{n+4}
R Serial Input	0 V	4.5 V	QD at tn+4



NOTES: A. The clock pulse generator has the following characteristics: $Z_{out}\approx 50~\Omega$ and PRR \leqslant 1 MHz, For '194, $t_r\leqslant$ 7 ns and $t_f\leqslant$ 7 ns. For 'LS194A, $t_r\leqslant$ 15 ns and $t_f\leqslant$ 6 ns. For 'S194, $t_r\leqslant$ 2.5 ns and $t_f\leqslant$ 2.5 ns. When testing f_{max} , vary PRR.

- B. C₁ includes probe and jig capacitance.
- C. All diodes are 1N3064 or 1N916.
- D. A clear pulse is applied prior to each test.
- E. For '194 and 'S194, V_{ref} = 1.5 V; for 'LS194A, V_{ref} = 1.3 V.
- F. Propagation delay times (tp_H and tpHL) are measured at tn+1. Proper shifting of data is verified at tn+4 with a functional test.
- G. $t_n = bit$ time before clocking transition. $t_{n+1} = bit$ time after one clocking transition.

 t_{n+4} = bit time after four clocking transitions.

FIGURE 1-SWITCHING TIMES



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